

FEATURES

- Operates from a Single 5V Supply
- Low Supply Current: $I_{CC} = 220\mu A$
- $I_{CC} = 0.2\mu A$ in Shutdown Mode
- ESD Protection Over $\pm 10kV$
- Uses Small Capacitors: $0.1\mu F$
- Operates to 120kBaud
- Output Overvoltage Does Not Force Current Back into Supplies
- RS232 I/O Lines Can Be Forced to $\pm 25V$ Without Damage
- Pin Compatible with LT1180A

APPLICATIONS

- Notebook Computers
- Palmtop Computers

DESCRIPTION

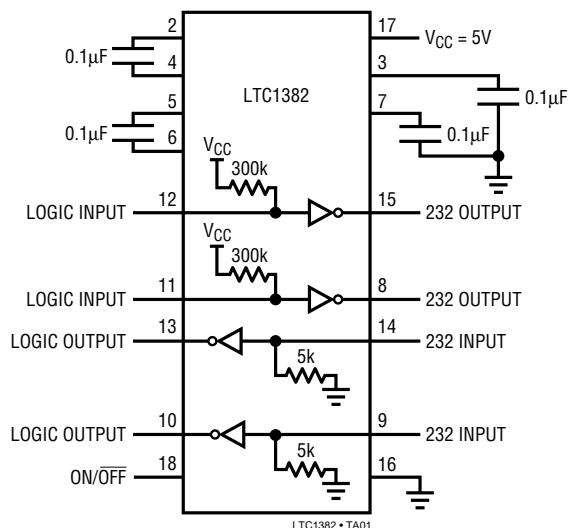
The LTC1382 is an ultra-low power 2-driver/2-receiver RS232 transceiver that operates from a single 5V supply. The charge pump requires only four space-saving $0.1\mu F$ capacitors.

The transceiver operates in one of two modes, Normal and Shutdown. In the Normal mode, I_{CC} is only $220\mu A$ with the driver outputs unloaded. In the Shutdown mode, the charge pump is turned off, the driver outputs are forced into three-state, both receivers are off and I_{CC} drops to $0.2\mu A$.

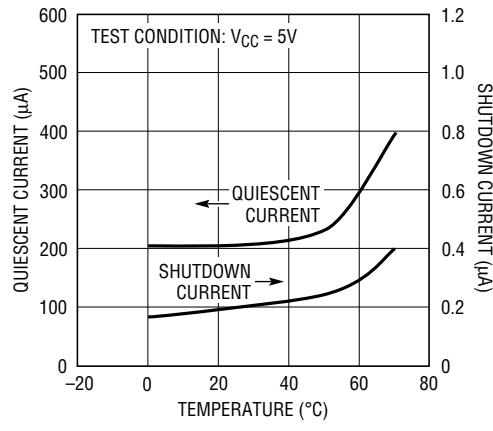
The LTC1382 is fully compliant with all data rate and overvoltage RS232 specifications. The transceiver can operate up to 120kbaud with a $2500pF$, $3k\Omega$ load. Both driver outputs and receiver inputs can be forced to $\pm 25V$ without damage and can survive multiple $\pm 10kV$ ESD strikes.

TYPICAL APPLICATION

2-Drivers/2-receivers with Shutdown



Quiescent and Shutdown Supply Current vs Temperature



ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC})	6V
Input Voltage	
Driver	-0.3V to $V_{CC} + 0.3V$
Receiver	-25V to 25V
Digital Input.....	-0.3V to $V_{CC} + 0.3V$
Output Voltage	
Driver	-25V to 25V
Receiver	-0.3V to $V_{CC} + 0.3V$
Short-Circuit Duration	
V^+	30 sec
V^-	30 sec
Driver Output.....	Indefinite
Receiver Output.....	Indefinite
Operating Temperature Range	0°C to 70°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

TOP VIEW	ORDER PART NUMBER
	LTC1382CN LTC1382CS
N PACKAGE 18-LEAD PLASTIC DIP S PACKAGE 18-LEAD PLASTIC SOL	

$T_{JMAX} = 125^\circ\text{C}$, $\theta_{JA} = 56^\circ\text{C/W}$ (N)
 $T_{JMAX} = 125^\circ\text{C}$, $\theta_{JA} = 85^\circ\text{C/W}$ (S)

Consult factory for Industrial and Military grade parts.

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 5\text{V}$, $C1 = C2 = C3 = C4 = 0.1\mu\text{F}$, $V_{ON/OFF} = V_{CC}$ unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Any Driver						
Output Voltage Swing	3k to GND	Positive Negative	● ●	5.0 -5.0	7.0 -6.5	V
Logic Input Voltage Level	Input Low Level ($V_{OUT} = \text{High}$) Input High Level ($V_{OUT} = \text{Low}$)	● ●		1.4 2.0	0.8 1.4	V
Logic Input Current	$V_{IN} = V_{CC}$ $V_{IN} = 0\text{V}$	● ●			5 -20	μA
Output Short-Circuit Current	$V_{OUT} = 0\text{V}$				± 12	mA
Output Leakage Current	Shutdown or $V_{CC} = 0\text{V}$ (Note 3), $V_{OUT} = \pm 20\text{V}$	●		± 10	± 500	μA
Any Receiver						
Input Voltage Thresholds	Input Low Threshold Input High Threshold	● ●		0.8 1.7	1.3 2.4	V
Hysteresis		●		0.1	0.4	1
Input Resistance	$-10\text{V} \leq V_{IN} \leq 10\text{V}$			3	5	$k\Omega$
Output Voltage	Output Low, $I_{OUT} = -1.6\text{mA}$ ($V_{CC} = 5\text{V}$) Output High, $I_{OUT} = 160\mu\text{A}$ ($V_{CC} = 5\text{V}$)	● ●		0.2 3.0	0.4 3.2	V
Output Short-Circuit Current	Sinking Current, $V_{OUT} = V_{CC}$ Sourcing Current $V_{OUT} = 0\text{V}$			-15 10	-40 20	mA
Output Leakage Current	Shutdown (Note 3), $0\text{V} \leq V_{OUT} \leq V_{CC}$	●		1	10	μA

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 5V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, $V_{ON/\bar{OFF}} = V_{CC}$, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supply Generator					
V^+ Output Voltage	$I_{OUT} = 0mA$ $I_{OUT} = 8mA$			8.0	V
				7.5	V
V^- Output Voltage	$I_{OUT} = 0mA$ $I_{OUT} = -8mA$			-8.0	V
				-7.0	V
Supply Rise Time	Shutdown to Turn-On			0.2	ms
Power Supply					
V_{CC} Supply Current	No Load (Note 2)	●	0.22	0.5	mA
Supply Leakage Current (V_{CC})	Shutdown (Note 3)	●	0.2	10	μA
Digital Input Threshold Low		●	1.4	0.8	V
Digital Input Threshold High		●	2.0	1.4	V

AC CHARACTERISTICS

$V_{CC} = 5V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Slew Rate	$R_L = 3k$, $C_L = 51pF$ $R_L = 3k$, $C_L = 2500pF$	3	5	8	$V/\mu s$
Driver Propagation Delay (TTL to RS232)	t_{HLD} (Figure 1) t_{LHD} (Figure 1)	● ●	2 2	3.5 3.5	μs
Receiver Propagation Delay (RS232 to TTL)	t_{HLR} (Figure 2) t_{LHR} (Figure 2)	● ●	0.3 0.3	0.8 0.8	μs

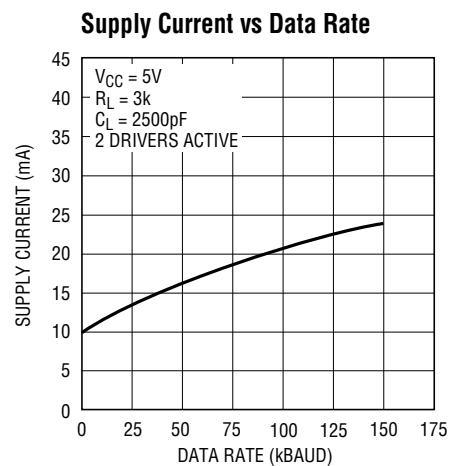
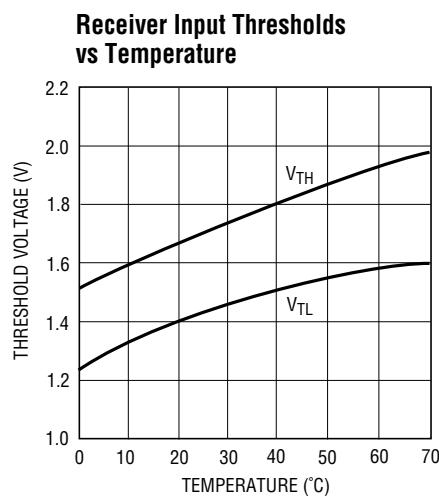
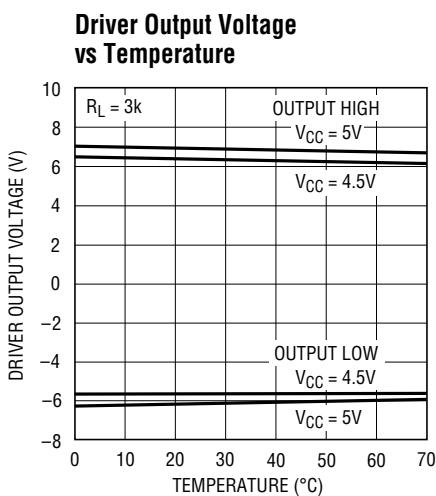
The ● denotes specifications which apply over the operating temperature range of $0^\circ C \leq T_A \leq 70^\circ C$.

Note 1: Absolute maximum ratings are those values beyond which the life of the device may be impaired.

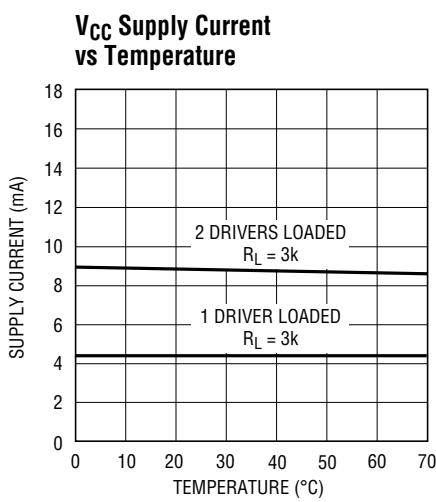
Note 2: Supply current is measured with driver and receiver outputs unloaded.

Note 3: Measurements made in the Shutdown mode are performed with $V_{ON/\bar{OFF}} = 0V$.

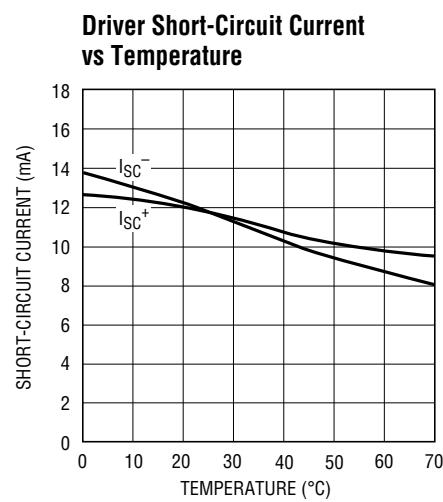
TYPICAL PERFORMANCE CHARACTERISTICS



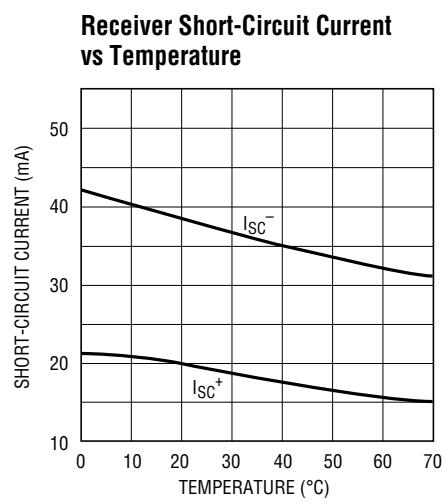
TYPICAL PERFORMANCE CHARACTERISTICS



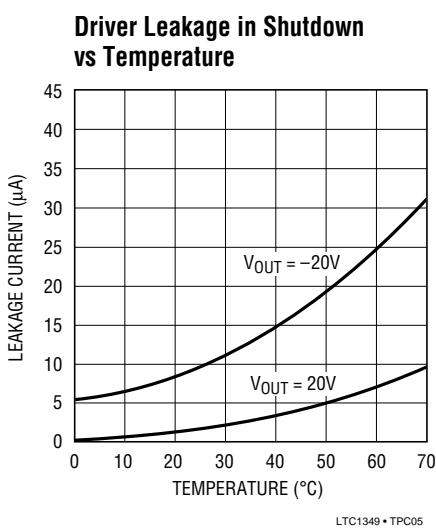
LTC1382 • TPC04



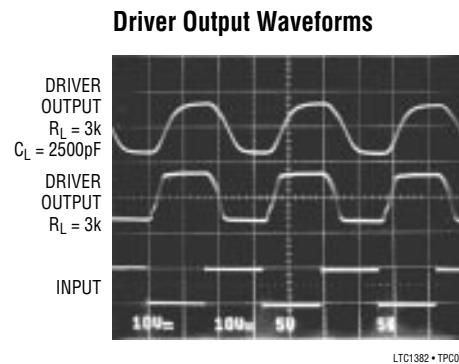
LTC1382 • TPC05



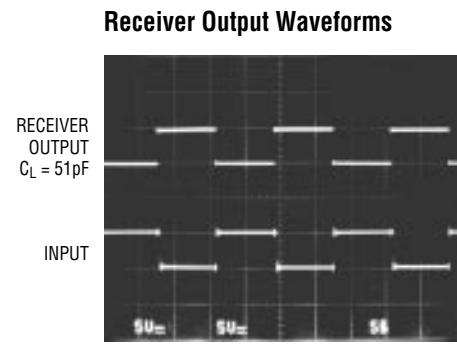
LTC1382 • TPC06



LTC1349 • TPC05



LTC1382 • TPC08



LTC1382 • TPC09

PIN FUNCTIONS

V_{CC}: 5V Input Supply Pin. This pin should be decoupled with a $0.1\mu\text{F}$ ceramic capacitor.

GND: Ground Pin.

ON/OFF: TTL/CMOS Compatible Shutdown Pin. A logic low puts the device in the Shutdown mode. Both driver outputs are forced into three-state and the supply current is $0.2\mu\text{A}$.

V⁺: Positive Supply Output (RS232 Drivers). $V^+ \geq 2V_{\text{CC}} - 2\text{V}$. This pin requires an external capacitor $C = 0.1\mu\text{F}$ for charge storage. The capacitor may be tied to ground or V_{CC} . With multiple devices, the V^+ and V^- pins may share a common capacitor. For large numbers of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

V⁻: Negative Supply Output (RS232 Drivers). $V^- \leq -(2V_{\text{CC}} - 2\text{V})$. This pin requires an external capacitor $C = 0.1\mu\text{F}$ for charge storage.

C1⁺, C1⁻, C2⁺, C2⁻: Commutating Capacitor Inputs. These pins require two external capacitors $C = 0.1\mu\text{F}$: one from $C1^+$ to $C1^-$ and another from $C2^+$ to $C2^-$. To maintain

charge pump efficiency, the capacitor's effective series resistance should be less than 2Ω .

TR IN: RS232 Driver Input Pins. Inputs are TTL/CMOS compatible. The inputs of unused drivers can be left unconnected since 300k input pull-up resistors to V_{CC} are included on chip. To minimize power consumption, the internal driver pull-up resistors are disconnected from V_{CC} in the Shutdown mode.

TR OUT: Driver Outputs at RS232 Voltage Levels. Outputs are in a high impedance state when in the Shutdown or $V_{\text{CC}} = 0\text{V}$. The driver outputs are protected against ESD to $\pm 10\text{kV}$ for human body model discharges.

RX IN: Receiver Inputs. These pins can be forced to $\pm 25\text{V}$ without damage. The receiver inputs are protected against ESD to $\pm 10\text{kV}$ for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity.

RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. Outputs are in a high impedance state when in the Shutdown mode.

SWITCHING TIME WAVEFORMS

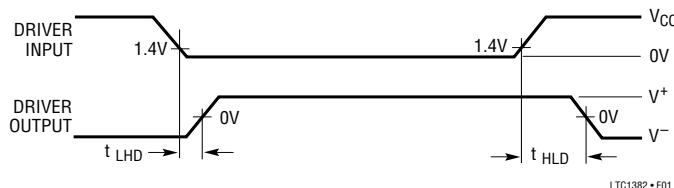


Figure 1. Driver Propagation Delay Timing

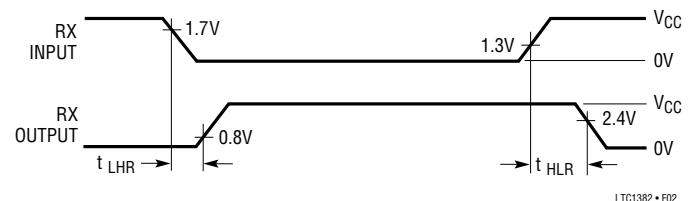
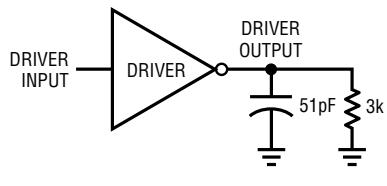


Figure 2. Receiver Propagation Delay Timing

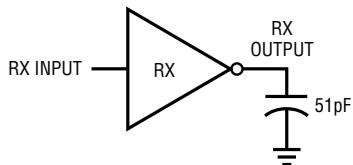
TEST CIRCUITS

Driver Timing Test Load



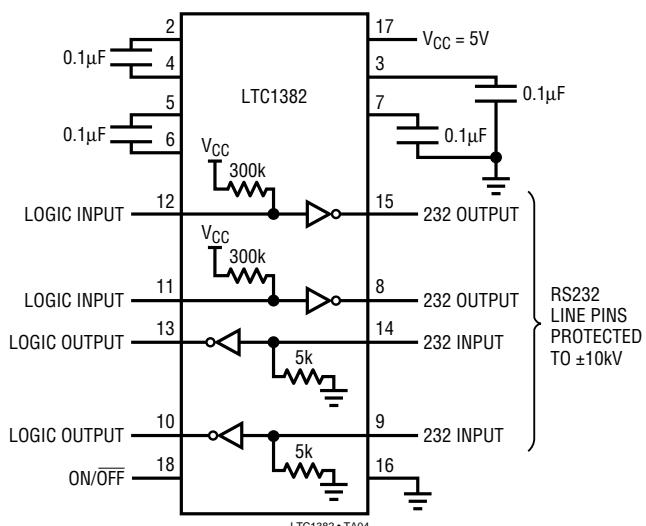
LTC1382 • TA03

Receiver Timing Test Load



LTC1382 • TA04

ESD Test Circuit

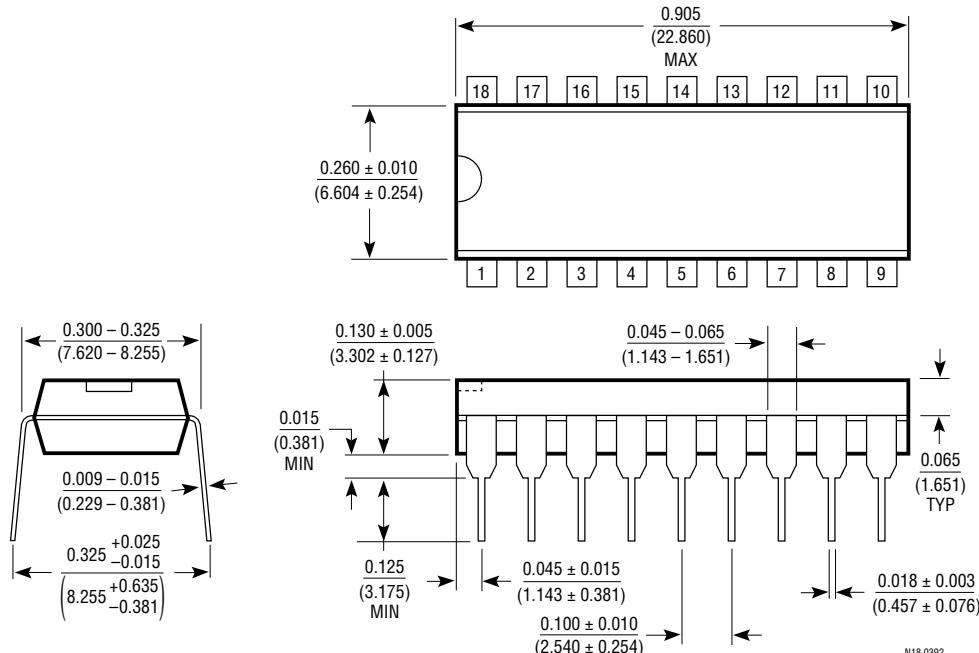


LTC1382 • TA04

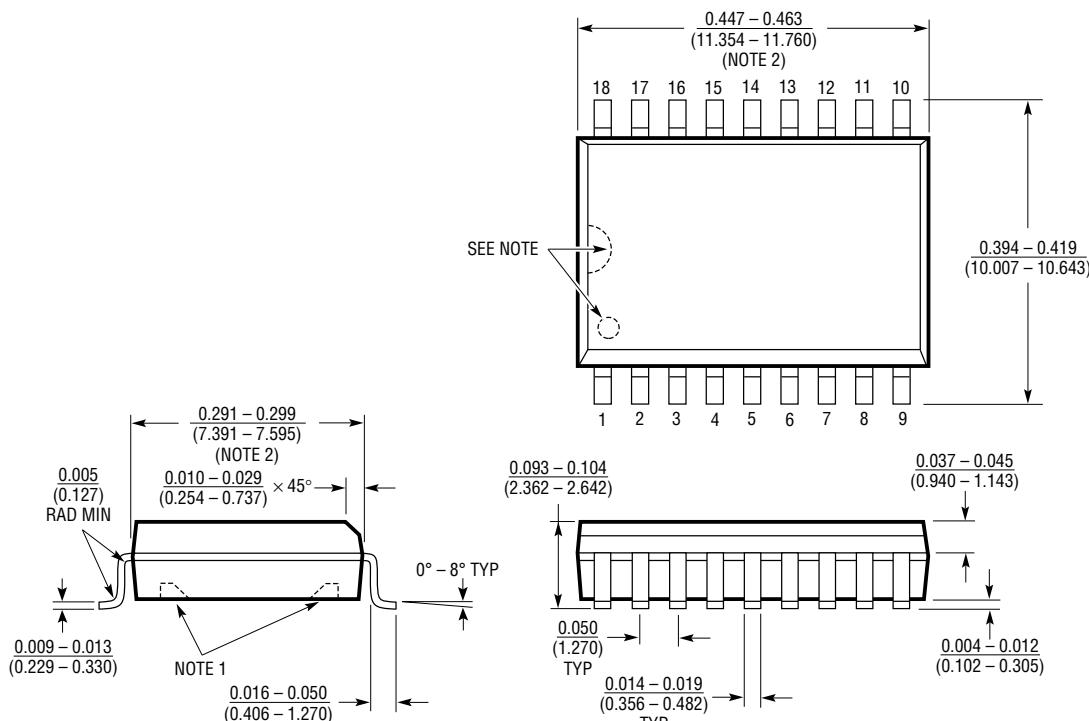
PACKAGE DESCRIPTION

Dimensions in inches (millimeters) unless otherwise noted.

N Package
18-Lead Plastic DIP



S Package
18-Lead Plastic SOL



NOTE:

1. PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS.

THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS.

2. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.006 INCH (0.15mm).

SOL18 0392

U.S. Area Sales Offices

NORTHEAST REGION

Linear Technology Corporation
One Oxford Valley
2300 E. Lincoln Hwy., Suite 306
Langhorne, PA 19047
Phone: (215) 757-8578
FAX: (215) 757-5631

Linear Technology Corporation
266 Lowell St., Suite B-8
Wilmington, MA 01887
Phone: (508) 658-3881
FAX: (508) 658-2701

SOUTHEAST REGION

Linear Technology Corporation
17060 Dallas Parkway
Suite 208
Dallas, TX 75248
Phone: (214) 733-3071
FAX: (214) 380-5138

CENTRAL REGION

Linear Technology Corporation
Chesapeake Square
229 Mitchell Court, Suite A-25
Addison, IL 60101
Phone: (708) 620-6910
FAX: (708) 620-6977

SOUTHWEST REGION

Linear Technology Corporation
22141 Ventura Blvd.
Suite 206
Woodland Hills, CA 91364
Phone: (818) 703-0835
FAX: (818) 703-0517

NORTHWEST REGION

Linear Technology Corporation
782 Sycamore Dr.
Milpitas, CA 95035
Phone: (408) 428-2050
FAX: (408) 432-6331

International Sales Offices

FRANCE

Linear Technology S.A.R.L.
Immeuble "Le Quartz"
58 Chemin de la Justice
92290 Chatenay Malabry
France
Phone: 33-1-41079555
FAX: 33-1-46314613

GERMANY

Linear Techonolgy GmbH
Untere Hauptstr. 9
D-85386 Eching
Germany
Phone: 49-89-3197410
FAX: 49-89-3194821

JAPAN

Linear Technology KK
5F YZ Bldg.
4-4-12 Iidabashi, Chiyoda-Ku
Tokyo, 102 Japan
Phone: 81-3-3237-7891
FAX: 81-3-3237-8010

KOREA

Linear Technology Korea Branch
Namsong Building, #505
Itaewon-Dong 260-199
Yongsan-Ku, Seoul
Korea
Phone: 82-2-792-1617
FAX: 82-2-792-1619

SINGAPORE

Linear Technology Pte. Ltd.
101 Boon Keng Road
#02-15 Kallang Ind. Estates
Singapore 1233
Phone: 65-293-5322
FAX: 65-292-0398

TAIWAN

Linear Technology Corporation
Rm. 801, No. 46, Sec. 2
Chung Shan N. Rd.
Taipei, Taiwan, R.O.C.
Phone: 886-2-521-7575
FAX: 886-2-562-2285

UNITED KINGDOM

Linear Technology (UK) Ltd.
The Coliseum, Riverside Way
Camberley, Surrey GU15 3YL
United Kingdom
Phone: 44-276-677676
FAX: 44-276-64851

World Headquarters

Linear Technology Corporation
1630 McCarthy Blvd.
Milpitas, CA 95035-7487
Phone: (408) 432-1900
FAX: (408) 434-0507

0294